

Vishay Siliconix

Dual N-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	I _D (A)				
20	0.385 at V _{GS} = 4.5 V	0.70			
20	0.630 at V _{GS} = 2.5 V	0.54			

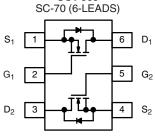
SOT-363 SC-70 (6-LEADS) S_1 D₁ 6 5 G_1 2 G_2 D_2 3 4 S_2

Top View

FEATURES

- Halogen-free According to IEC 61249-2-21 ٠ Definition
- TrenchFET[®] Power MOSFETs: 2.5 V Rated
- 100 % R_g Tested •
- Compliant to RoHS Directive 2002/95/EC





Marking Code PA x≿



Ordering Information: Si1902DL-T1-E3 (Lead (Pb)-free with Tape and Reel) Si1902DL-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)					
Parameter	Symbol	5 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	20		v
Gate-Source Voltage		V _{GS}	±12		
	T _A = 25 °C	- I _D	0.70	0.66	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		0.50	0.48	
Pulsed Drain Current		I _{DM}	1		A
Continuous Source Current (Diode Conduction) ^a		ا _S	0.25	0.23	1
	T _A = 25 °C	PD	0.30	0.27	w
Maximum Power Dissipation ^a	T _A = 85 °C		0.16	0.14	vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 1	to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
	t ≤ 5 s	B	360	415		
Maximum Junction-to-Ambient ^a	Steady State	R _{thJA}	400	460	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	300	350		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

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Parameter	Symbol Test Conditions		Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.6		1.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
		$V_{DS} = 16 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	V _{DS} = 16 V, V _{GS} = 0 V		1	μΑ	
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 16 V_{GS} = 0 V$, $T_{J} = 85^{\circ}C$			5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \geq 5$ V, $V_{GS} = 4.5$ V	1			А	
	Р	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.66 \text{ A}$	0.320 0.385				
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 0.40 \text{ A}$		0.560	0.630	Ω	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 0.66 \text{ A}$		1.5		S	
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = 0.23 A, $V_{\rm GS}$ = 0 V		0.8	1.2	V	
Dynamic ^b	<u>I</u> I		I		1		
Total Gate Charge	Qg			0.8	1.2		
Gate-Source Charge	Q _{gs}	V_{DS} = 10 V, V_{GS} = 4.5 V, I_{D} = 0.66 A		0.06		nC	
Gate-Drain Charge	Q _{gd}			0.30			
Gate Resistance	Rg	f = 1 MHz	0.2	1	1.7	Ω	
Turn-On Delay Time	t _{d(on)}			10	20		
Rise Time	t _r	V_{DD} = 10 V, R_L = 20 Ω		16	30		
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 0.5$ A, V_{GEN} = 4.5 V, R_g = 6 Ω		10	20	ns	
Fall Time	t _f			10	20		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 0.23 A, dl/dt = 100 A/μs		20	40		

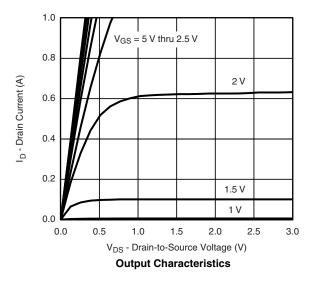
Notes:

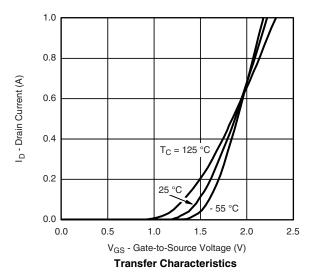
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





www.vishay.com 2 Document Number: 71080 S11-2043-Rev. J, 17-Oct-11

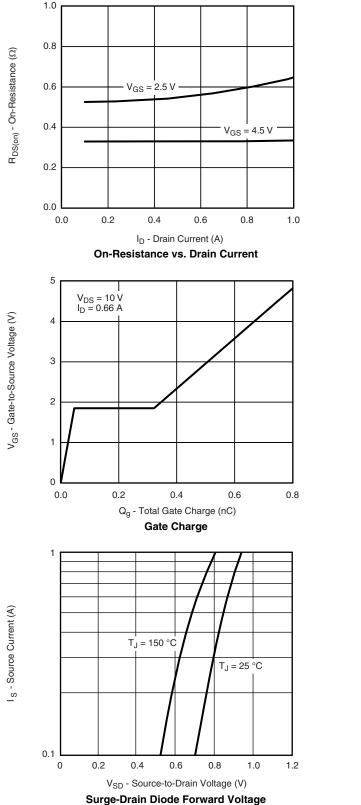
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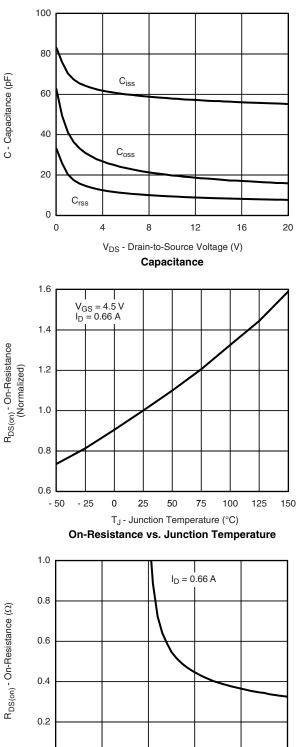


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





0.0

0

1

2

3

 V_{GS} - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage

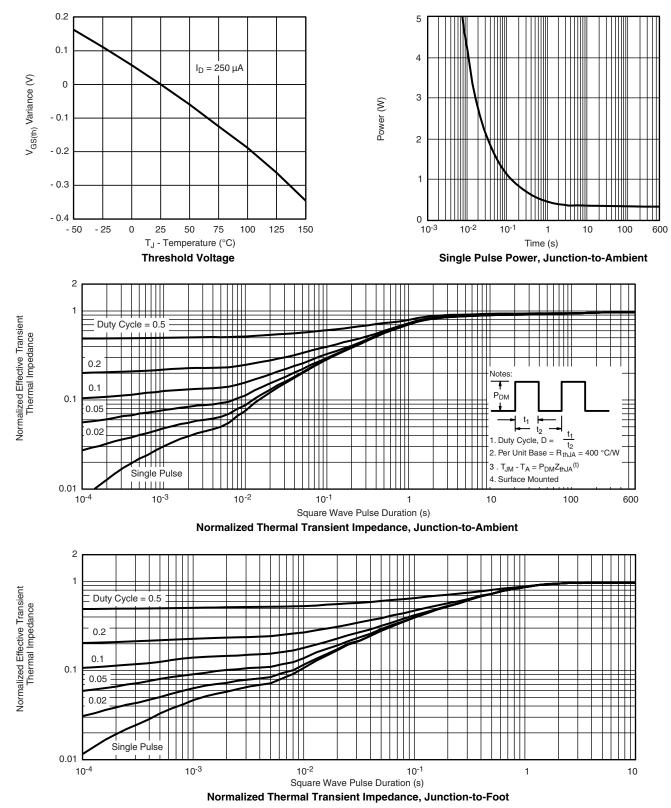
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4

Si1902DL

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71080.

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Package Information Vishay Siliconix

SC-70: 6-LEADS





	MILLIMETERS			I	INCHES		
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.90	-	1.10	0.035	-	0.043	
A ₁	-	-	0.10	-	-	0.004	
A ₂	0.80	-	1.00	0.031	-	0.039	
b	0.15	-	0.30	0.006	-	0.012	
С	0.10	-	0.25	0.004	-	0.010	
D	1.80	2.00	2.20	0.071	0.079	0.087	
Е	1.80	2.10	2.40	0.071	0.083	0.094	
E ₁	1.15	1.25	1.35	0.045	0.049	0.053	
е		0.65BSC			0.026BSC	;	
e ₁	1.20	1.30	1.40	0.047	0.051	0.055	
L	0.10	0.20	0.30	0.004	0.008	0.012	
٩	♀ 7°Nom 7°Nom						
ECN: S-03946—Rev. B, 09-Jul-01 DWG: 5550							



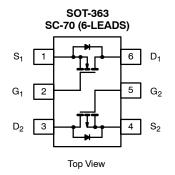
Dual-Channel LITTLE FOOT® SC-70 6-Pin MOSFET Recommended Pad Pattern and Thermal Performance

INTRODUCTION

This technical note discusses the pin-outs, package outlines, pad patterns, evaluation board layout, and thermal performance for dual-channel LITTLE FOOT power MOSFETs in the SC-70 package. These new Vishay Siliconix devices are intended for small-signal applications where a miniaturized package is needed and low levels of current (around 250 mA) need to be switched, either directly or by using a level shift configuration. Vishay provides these devices with a range of on-resistance specifications in 6-pin versions. The new 6-pin SC-70 package enables improved on-resistance values and enhanced thermal performance.

PIN-OUT

Figure 1 shows the pin-out description and Pin 1 identification for the dual-channel SC-70 device in the 6-pin configuration.





For package dimensions see outline drawing SC-70 (6-Leads) (http://www.vishay.com/doc?71154)

BASIC PAD PATTERNS

See Application Note 826, *Recommended Minimum Pad Patterns With Outline Drawing Access for Vishay Siliconix MOSFET*s, (http://www.vishay.com/doc?72286) for the 6-pin SC-70. This basic pad pattern is sufficient for the low-power applications for which this package is intended. For the 6-pin device, increasing the pad patterns yields a reduction in thermal resistance on the order of 20% when using a 1-inch square with full copper on both sides of the printed circuit board (PCB).

EVALUATION BOARDS FOR THE DUAL SC70-6

The 6-pin SC-70 evaluation board (EVB) measures 0.6 inches by 0.5 inches. The copper pad traces are the same as described in the previous section, *Basic Pad Patterns*. The board allows interrogation from the outer pins to 6-pin DIP connections permitting test sockets to be used in evaluation testing.

The thermal performance of the dual SC-70 has been measured on the EVB with the results shown below. The minimum recommended footprint on the evaluation board was compared with the industry standard 1-inch square FR4 PCB with copper on both sides of the board.

THERMAL PERFORMANCE

Junction-to-Foot Thermal Resistance (the Package Performance)

Thermal performance for the dual SC-70 6-pin package measured as junction-to-foot thermal resistance is 300°C/W typical, 350°C/W maximum. The "foot" is the drain lead of the device as it connects with the body. Note that these numbers are somewhat higher than other LITTLE FOOT devices due to the limited thermal performance of the Alloy 42 lead-frame compared with a standard copper lead-frame.

Junction-to-Ambient Thermal Resistance (dependent on PCB size)

The typical $R\theta_{JA}$ for the dual 6-pin SC-70 is 400°C/W steady state. Maximum ratings are 460°C/W for the dual. All figures based on the 1-inch square FR4 test board. The following example shows how the thermal resistance impacts power dissipation for the dual 6-pin SC-70 package at two different ambient temperatures.



SC-70 (6-PIN)					
Room Ambient 25 °C	Elevated Ambient 60 °C				
$P_{D} = \frac{T_{J(max)} - T_{A}}{R\theta_{JA}}$	$P_{D} = \frac{T_{J(max)} - T_{A}}{R\boldsymbol{\theta}_{JA}}$				
$P_{D} = \frac{150^{\circ}C - 25^{\circ}C}{400^{\circ}C/W}$	$P_{D} = \frac{150^{\circ}C - 60^{\circ}C}{400^{\circ}C/W}$				
$P_D = 312 \text{ mW}$	$P_D = 225 \text{ mW}$				

NOTE: Although they are intended for low-power applications, devices in the 6-pin SC-70 will handle power dissipation in excess of 0.2 W.

Testing

To aid comparison further, Figure 2 illustrates the dual-channel SC-70 thermal performance on two different board sizes and two different pad patterns. The results display the thermal performance out to steady state. The measured steady state values of $R\theta_{JA}$ for the dual 6-pin SC-70 are as follows:

LITTLE FOOT SC-70 (6-PIN)				
1) Minimum recommended pad pattern (see Figure 2) on the EVB of 0.5 inches x 0.6 inches.	518°C/W			
2) Industry standard 1" square PCB with maximum copper both sides.	413°C/W			

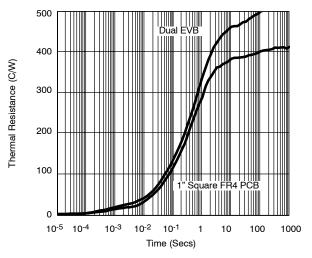


FIGURE 2. Comparison of Dual SC70-6 on EVB and 1" Square FR4 PCB.

The results show that if the board area can be increased and maximum copper traces are added, the thermal resistance reduction is limited to 20%. This fact confirms that the power dissipation is restricted with the package size and the Alloy 42 leadframe.

ASSOCIATED DOCUMENT

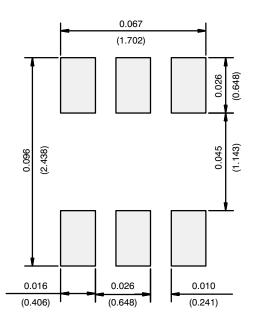
Single-Channel LITTLE FOOT SC-70 6-Pin MOSFET Copper Leadframe Version, REcommended Pad Pattern and Thermal Performance, AN815, (http://www.vishay.com/doc?71334).

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SC-70: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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